



MULTI-INNO TECHNOLOGY CO., LTD.

www.multi-inno.com

LCD MODULE SPECIFICATION

Model : MI0283QT-17

This module uses ROHS material

For Customer's Acceptance:

Customer	
Approved	
Comment	

The standard product specification may change without prior notice in order to improve performance or quality. Please contact Multi-Inno for updated specification and product status before design for the standard product or release of the order.

Revision	1.2
Engineering	
Date	2016-12-01
Our Reference	

REVISION RECORD

[illegible]



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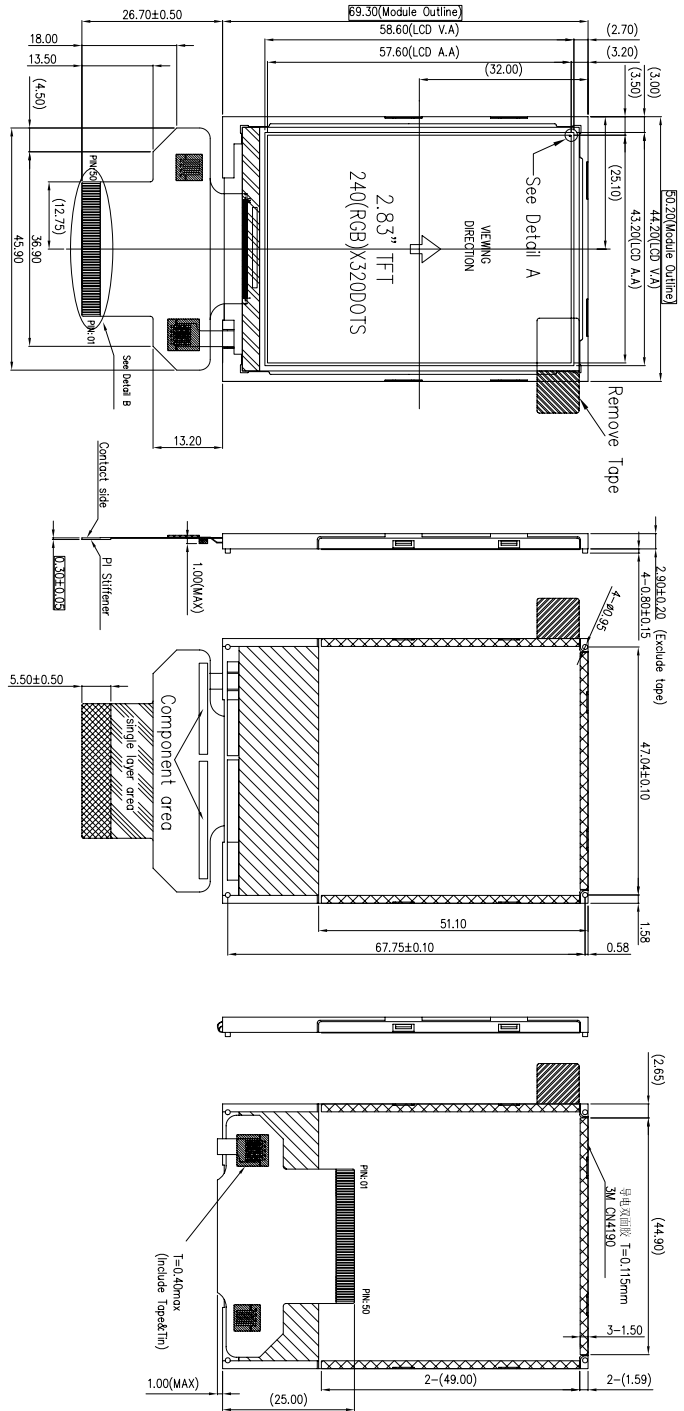
**■ GENERAL INFORMATION**

Item	Contents	Unit/Note
LCD type	TFT/TRANSMISSIVE/POSITIVE	/
Viewing direction	6:00 (without image inversion and least brightness change)	O'Clock
Gray scale inversion direction	12:00 (contrast peak located at)	O'Clock
Module area (W × H)	50.2×69.3×2.9	mm ³
Active area (W×H)	43.2×57.6	mm ²
Number of Dots	240(RGB)×320	/
Pixel pitch(W × H)	0.18 × 0.18	mm ²
DriverIC	ILI9341V	/
Colors	65K/262K	/
Backlight Type	4 LEDs	/
Module Power consumption	298(max.)	mw
InterfaceType	CPU/RGB/SPI	/
Input voltage	2.8	V
With/Without TSP	Without TSP	/
Weight	22.5	g

Note 1: RoHS compliant;

Note 2: LCM weight tolerance: ± 5% .

EXTERNAL DIMENSIONS

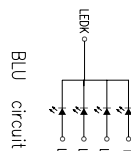
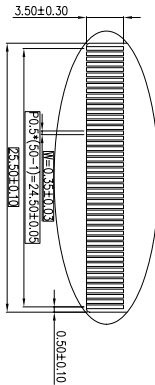
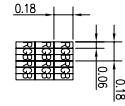


NOTES:

1. DISPLAY TYPE: TFT, TRANSMISSIVE, POSITIVE.
2. OPERATING VOLTAGE: VDD/VCI=2.8V.
3. VIEWING DIRECTION: 6 O'CLOCK.
4. IC DRIVER: IL9341V.
5. OPERATING TEMP: -20°C ~ 70°C.
6. STORAGE TEMP: -30°C ~ 80°C.
7. INTERFACE: CPU/RGB INTERFACE.
8. SURFACE LUMINANCE: 650cd/m²(TYP.)
9. LED BACKLIGHT: 4-CHIP WHITE LED, I_f=80mA, V_f=3.2V.
10. GENERAL TOLERANCE: ±0.2.
11. RECOMMENDED CASE OPEN AREA SHOULD BE LESS THAN LCD V.A.
12. ROHS COMPLIANT.

Detail A
Scale 20:1

Detail B
Scale 2:1



LEDK pin list



MULTI-INNO TECHNOLOGY CO.,LTD.

DRAWN BY: CAROL 2015.12.16 SCALE: 1/1

CHECKED BY: 2015.12.16

VER. 01 FIRST ISSUE 2014.11.24 APPROVED BY: 02

UNIT: mm

DESCRIPTION: TFT MODULE

**■ABSOLUTE MAXIMUM RATINGS**

Parameter	Symbol	Min	Max	Unit
Power supply voltage	VCI	-0.3	4.6	V
Logic signal voltage	VDDI	-0.3	4.6	V
Operatingtemperature	Top	-20	70	°C
Storage temperature	TST	-30	80	°C
Humidity	RH	-	90%(Max60 °C)	RH

■ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS

Parameter	Symbol	Min	Typ	Max	Unit
Power supply voltage	VCI	2.5	2.8	3.3	V
Logic signalI/O voltage	VDDI	1.65	2.8	3.3	V
Inputvoltage'H'level	VIH	0.7VDDI	-	VDDI	V
Inputvoltage'L'level	VIL	VSS	-	0.3VDDI	V
Outputvoltage'H'level	VOH	0.8VDDI	-	VDDI	V
Outputvoltage'L'leve	VOL	VSS	-	0.2VDDI	V

■ BACKLIGHT CHARACTERISTICS

Item	Symbol	Min.	Typ.	Max.	Unit	Condition
Forward voltage	Vf	-	3.2	-	V	Ta=25±2°C, 60%RH±5%
Forward current	If	-	80	-	mA	
Power consumption	W _{BL}	-	256	-	mW	
Operating life time	-	30000	40000	-	Hrs	

Note :

Operating life time means brightness goes down to 50% initial brightness;

The life time of LED will be reduced if LED is driven by high current,high ambient temperature and humidity conditions;

Typical operating life time is an estimated data.

■ELECTRO-OPTICAL CHARACTERISTICS

Item	Symbol	Condition	Min	Typ	Max	Unit	Remark	Note
Response time	Tr +Tf	$\theta=0^\circ$ $\varnothing=0^\circ$ $T_a=25^\circ\text{C}$	-	25	30	ms	Fig.1	4
Contrastratio	Cr		-	500	-	--	FIG 2.	1
Luminance uniformity	δ WHITE		80	90	-	%	FIG 2.	3
Surface Luminance	Lv		-	650	-	cd/m ²	FIG 2.	2
Viewing angle range	θ	$\varnothing = 90^\circ$	-	70	-	deg	FIG 3.	6
		$\varnothing = 270^\circ$	-	57	-	deg	FIG 3.	
		$\varnothing = 0^\circ$	-	70	-	deg	FIG 3.	
		$\varnothing = 180^\circ$	-	70	-	deg	FIG 3.	
CIE (x, y) chromaticity	Red x	$\theta=0^\circ$ $\varnothing=0^\circ$ $T_a=25^\circ\text{C}$	-	0.6368	-		FIG 2.	5
	Red y		-	0.3329	-			
	Green x		-	0.3397	-			
	Green y		-	0.6138	-			
	Blue x		-	0.1433	-			
	Blue y		-	0.0807	-			
	White x		-	0.2886	-			
	White y		-	0.3194	-			
NTSC Ratio	S		55	67	-	%		

Note 1. Contrast Ratio(CR) is defined mathematically as For more information see FIG 2.:

$$\text{Contrast Ratio} = \frac{\text{Average Surface Luminance with all white pixels } (P_1, P_2, P_3, P_4, P_5)}{\text{Average Surface Luminance with all black pixels } (P_1, P_2, P_3, P_4, P_5)}$$

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

$$L_v = \text{Average Surface Luminance with all white pixels } (P_1, P_2, P_3, P_4, P_5)$$

Note 3. The uniformity in surface luminance, δ WHITE is determined by measuring luminance at each test position 1 through 5, and then dividing the maximum luminance of 5 points luminance by minimum luminance of 5 points luminance. For more information see FIG 2.

$$\delta \text{ WHITE} = \frac{\text{Minimum Surface Luminance with all white pixels } (P_1, P_2, P_3, P_4, P_5)}{\text{Maximum Surface Luminance with all white pixels } (P_1, P_2, P_3, P_4, P_5)}$$

Note 4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1. The test equipment is Autronic-Melchers's ConoScope. Series

Note 5. CIE (x, y) chromaticity, The x,y value is determined by measuring luminance at each test position 1 through 5, and then make average value

Note 6. Viewing angle is the angle at which the contrast ratio is greater than 2. For TFT module the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

Note 7. For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity, CIE The test data is base on TOPCON's BM-5 photo detector.

Note 8. For TFT module, Gray scale reverse occurs in the direction of panel viewing angle.

FIG.1. The definition of Response Time

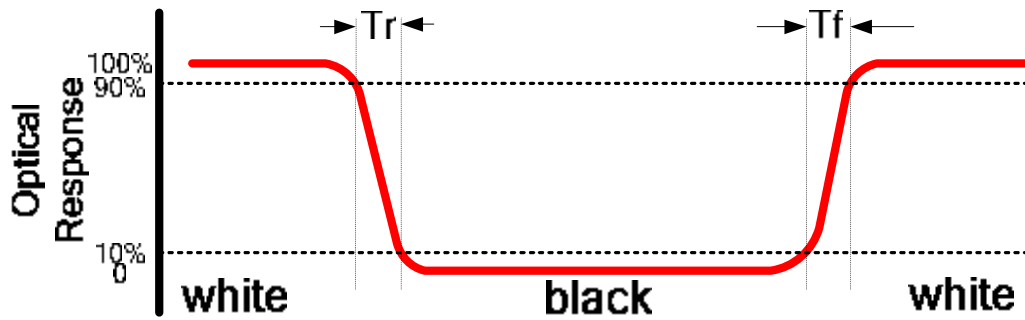


FIG.2. Measuring method for Contrast ratio,surface luminance, Luminance uniformity , CIE (x, y) chromaticity

A : 5 mm
B : 5 mm
H,V : Active Area
Light spot size $\varnothing=5\text{mm}$, 500mm distance from the LCD surface to detector lens
measurement instrument is TOPCON's luminance meter BM-5

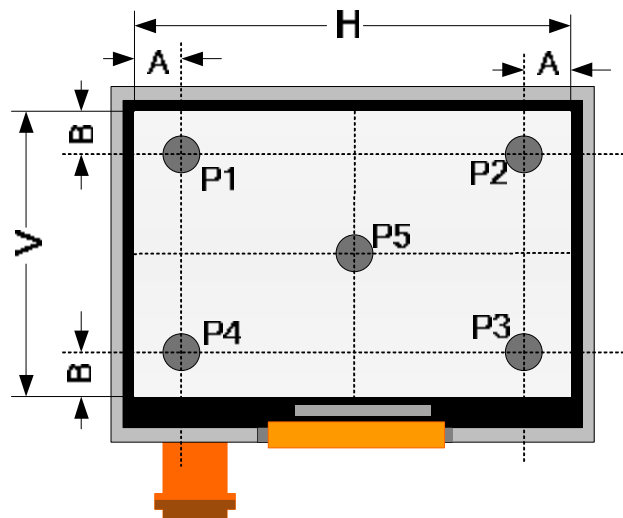
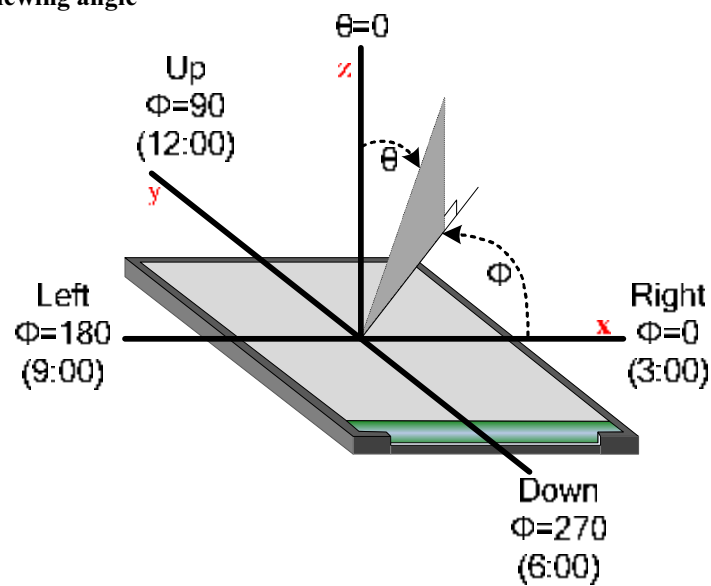


FIG.3. The definition of viewing angle



■ INTERFACE DESCRIPTION

Pin No.	Symbol	I/O	Function
1	LEDK	I	Cathode for LED backlighting
2	LEDA1	I	Anode No.1 for LED backlighting
3	LEDA2	I	Anode No.2 for LED backlighting
4	LEDA3	I	Anode No.3 for LED backlighting
5	LEDA4	I	Anode No.4 for LED backlighting
6	IM0	I	Select Interface Mode ;Note1
7	IM1	I	
8	IM2	I	
9	IM3	I	
10	RESET	I	Reset pin
11	VSYNC	IO	Frame Synchronizing Signal For RGB Interface
12	HSYNC	IO	Line Synchronizing Signal For RGB Interface
13	DOTCLK	IO	Dot Clock Signal For RGB Interface
14	DE	IO	Data Enable Signal For RGB Interface
15 32	DB17 DB0	IO	DATA BUS If customer choose RGB interface, the data bus information is as below: DB0 -DB5 : B0-B5 DB6 -DB11: G0-G5 DB12-DB17 : R0-R5
33	SDO	IO	Serial Output Signal
34	SDI	IO	Serial Input Signal
35	RD	IO	Read execution control pin
36	WRX(D/CX)	IO	Write execution control pin ; Serial Register select s Signal
37	D/CX(SCL)	IO	Register select signal; Serial Interface Clock
38	CSX	IO	Chip Select Signal
39	TE	IO	Tearing effect out pin synchronize MPU to frame writng
40	VDDI	P	Logic power , provide with 1.8/2.8V
41	VDDI	P	Logic power , provide with 1.8/2.8V
42	VCI	P	Power Supply to the interface pins ,provide with 2.8V
43	GND	G	Ground
44	NC	-	Noconnection
45	NC	-	Noconnection
46	NC	-	Noconnection
47	NC	-	Noconnection
48	GND	O	Ground
49	GND	O	Ground
50	GND	-	Ground



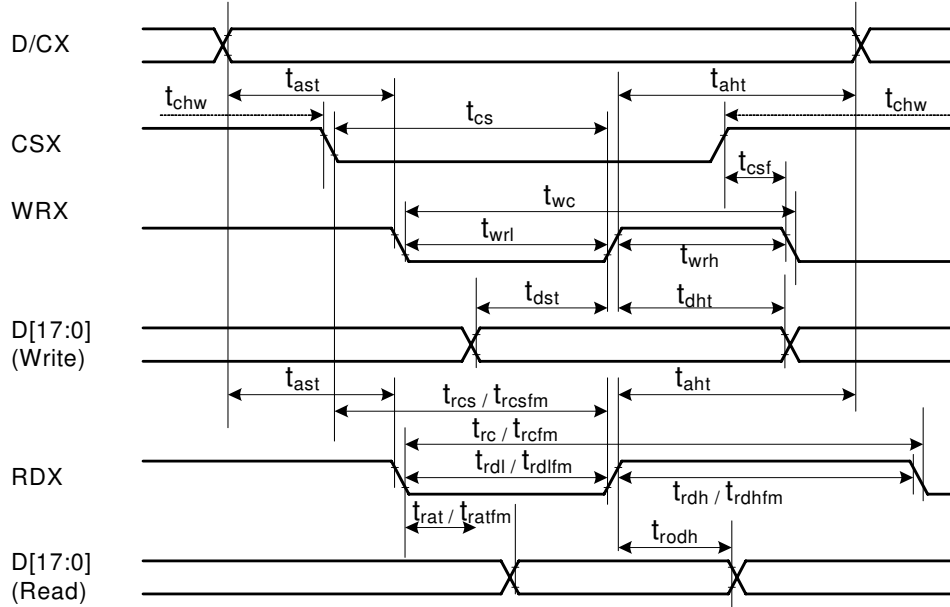
NOTE1:

IM3	IM2	IM1	IM0	MCU-Interface Mode	Pins in use	
					Register/Content	GRAM
0	0	0	0	8080 MCU 8-bit bus interface I	D[7:0]	D[7:0],WRX,RDX,CSX,D/CX
0	0	0	1	8080 MCU 16-bit bus interface I	D[7:0]	D[15:0],WRX,RDX,CSX,D/CX
0	0	1	0	8080 MCU 9-bit bus interface I	D[7:0]	D[8:0],WRX,RDX,CSX,D/CX
0	0	1	1	8080 MCU 18-bit bus interface I	D[7:0]	D[17:0],WRX,RDX,CSX,D/CX
0	1	0	1	3-wire 9-bit data serial interface I	SCL,SDA,CSX	
0	1	1	0	4-wire 8-bit data serial interface I	SCL,SDA,D/CX,CSX	
1	0	0	0	8080 MCU 16-bit bus interface II	D[8:1]	D[17:10],D[8:1],WRX,RDX,CSX,D/CX
1	0	0	1	8080 MCU 8-bit bus interface II	D[17:10]	D[17:10],WRX,RDX,CSX,D/CX
1	0	1	0	8080 MCU 18-bit bus interface II	D[8:1]	D[17:0],WRX,RDX,CSX,D/CX
1	0	1	1	8080 MCU 9-bit bus interface II	D[17:10]	D[17:9],WRX,RDX,CSX,D/CX
1	1	0	1	3-wire 9-bit data serial interface II	SCL,SDI,SDO, CSX	
1	1	1	0	4-wire 8-bit data serial interface II	SCL,SDI,D/CX,SDO, CSX	

■ APPLICATION NOTES

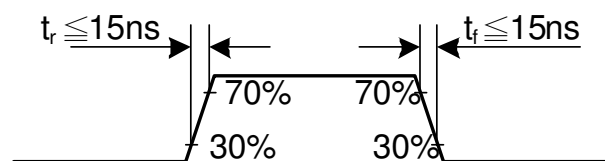
1. AC Characteristics

1.1 Display Parallel 18/16/9/8-bit Interface Timing Characteristics (8080- I system)

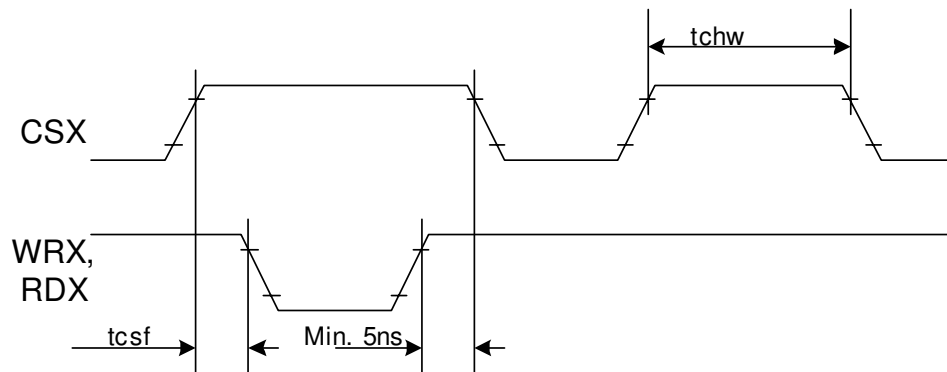


Signal	Symbol	Parameter	min	max	Unit	Description
DCX	t _{ast}	Address setup time	0	-	ns	
	t _{ahh}	Address hold time (Write/Read)	0	-	ns	
CSX	t _{chw}	CSX "H" pulse width	0	-	ns	
	t _{cs}	Chip Select setup time (Write)	15	-	ns	
	t _{rcs}	Chip Select setup time (Read ID)	45	-	ns	
	t _{rcsfm}	Chip Select setup time (Read FM)	355	-	ns	
WRX	t _{csf}	Chip Select Wait time (Write/Read)	10	-	ns	
	t _{wc}	Write cycle	66	-	ns	
	t _{wrl}	Write Control pulse L duration	15	-	ns	
	t _{wrh}	Write Control pulse H duration	15	-	ns	
RDX (FM)	t _{trcfm}	Read Cycle (FM)	450	-	ns	
	t _{trdhfm}	Read Control H duration (FM)	90	-	ns	
	t _{trdlfm}	Read Control L duration (FM)	355	-	ns	
RDX (ID)	t _{trc}	Read cycle (ID)	160	-	ns	
	t _{trdh}	Read Control pulse H duration	90	-	ns	
	t _{trdl}	Read Control pulse L duration	45	-	ns	
D[17:0], D[15:0], D[8:0], D[7:0]	t _{dst}	Write data setup time	10	-	ns	For maximum CL=30pF For minimum CL=8pF
	t _{dht}	Write data hold time	10	-	ns	
	t _{rat}	Read access time	-	40	ns	
	t _{ratfm}	Read access time	-	340	ns	
	t _{rod}	Read output disable time	20	80	ns	

Note: Ta = -30 to 70 °C, VDDI=1.65V to 3.3V, VCI=2.5V to 3.3V, VSS=0V

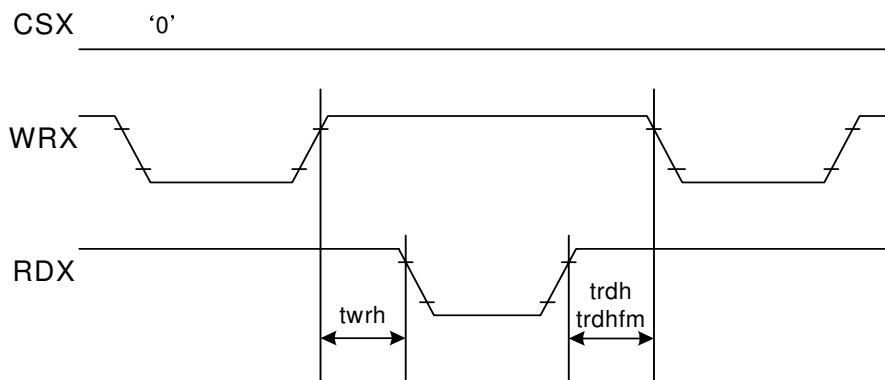


CSX timings :



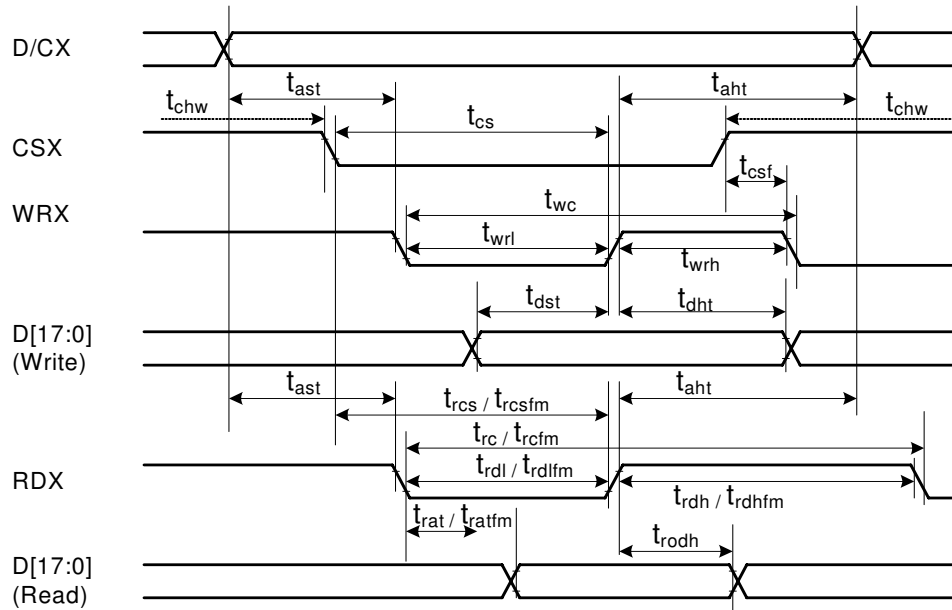
Note: Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

Write to read or read to write timings:



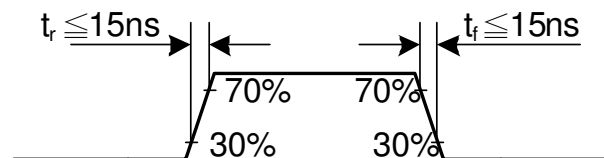
Note: Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

1.2 Display Parallel 18/16/9/8-bit Interface Timing Characteristics(8080- II system)

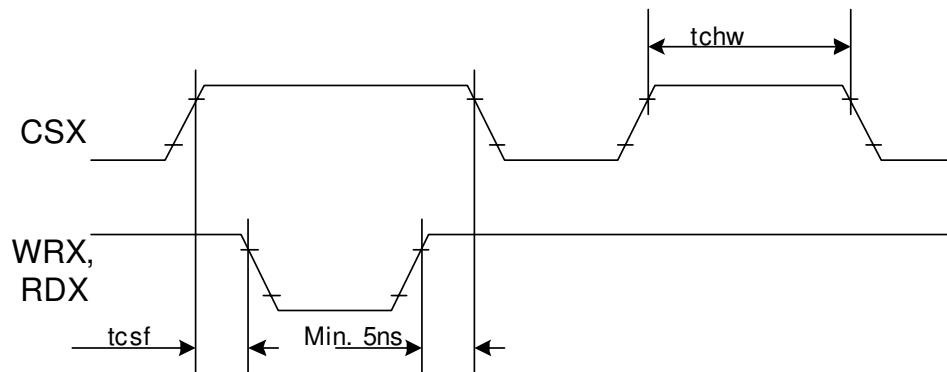


Signal	Symbol	Parameter	min	max	Unit	Description
DCX	tast	Address setup time	0	-	ns	
	taht	Address hold time (Write/Read)	0	-	ns	
CSX	tchw	CSX "H" pulse width	0	-	ns	
	tcs	Chip Select setup time (Write)	15	-	ns	
	trcs	Chip Select setup time (Read ID)	45	-	ns	
	trcsfm	Chip Select setup time (Read FM)	355	-	ns	
	tcsf	Chip Select Wait time (Write/Read)	10	-	ns	
WRX	twc	Write cycle	66	-	ns	
	twrh	Write Control pulse H duration	15	-	ns	
	twrl	Write Control pulse L duration	15	-	ns	
RDX (FM)	trcfm	Read Cycle (FM)	450	-	ns	
	trdhfm	Read Control H duration (FM)	90	-	ns	
	trdlfm	Read Control L duration (FM)	355	-	ns	
RDX (ID)	trc	Read cycle (ID)	160	-	ns	
	trdh	Read Control pulse H duration	90	-	ns	
	trdl	Read Control pulse L duration	45	-	ns	
D[17:0], D[17:10]&D[8:1], D[17:10], D[17:9]	tdst	Write data setup time	10	-	ns	For maximum CL=30pF For minimum CL=8pF
	tdht	Write data hold time	10	-	ns	
	trat	Read access time	-	40	ns	
	tratfm	Read access time	-	340	ns	
	trod	Read output disable time	20	80	ns	

Note: $T_a = -30$ to 70°C , $V_{DDI}=1.65\text{V}$ to 3.3V , $V_{CI}=2.5\text{V}$ to 3.3V , $V_{SS}=0\text{V}$.

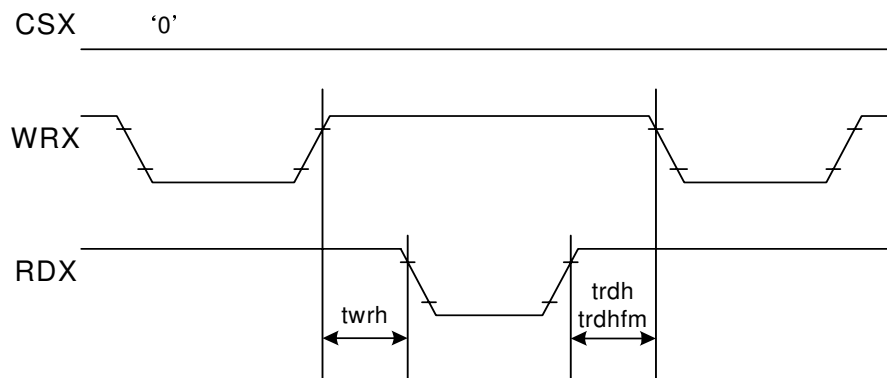


CSX timings :



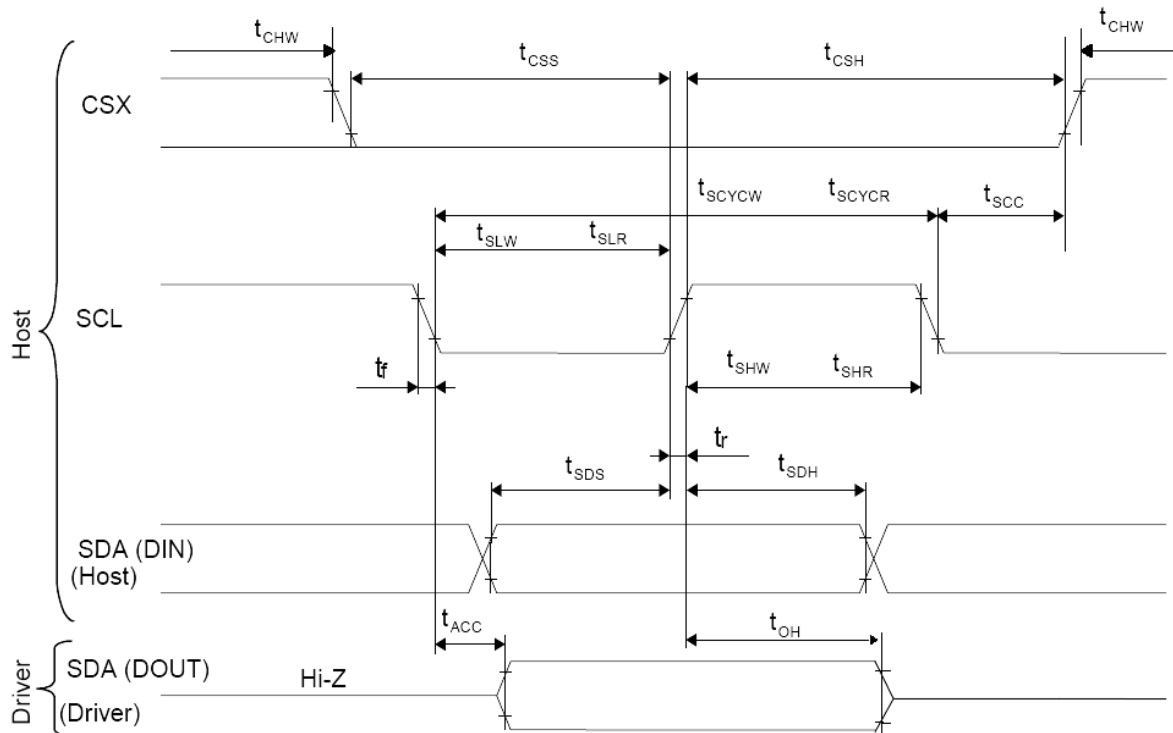
Note: Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

Write to read or read to write timings:



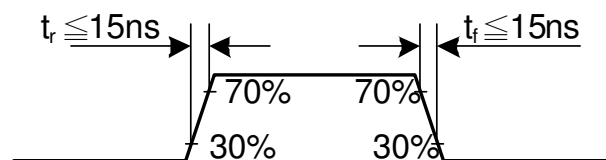
Note: Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

1.3 Display Serial Interface Timing Characteristics (3-line SPI system)

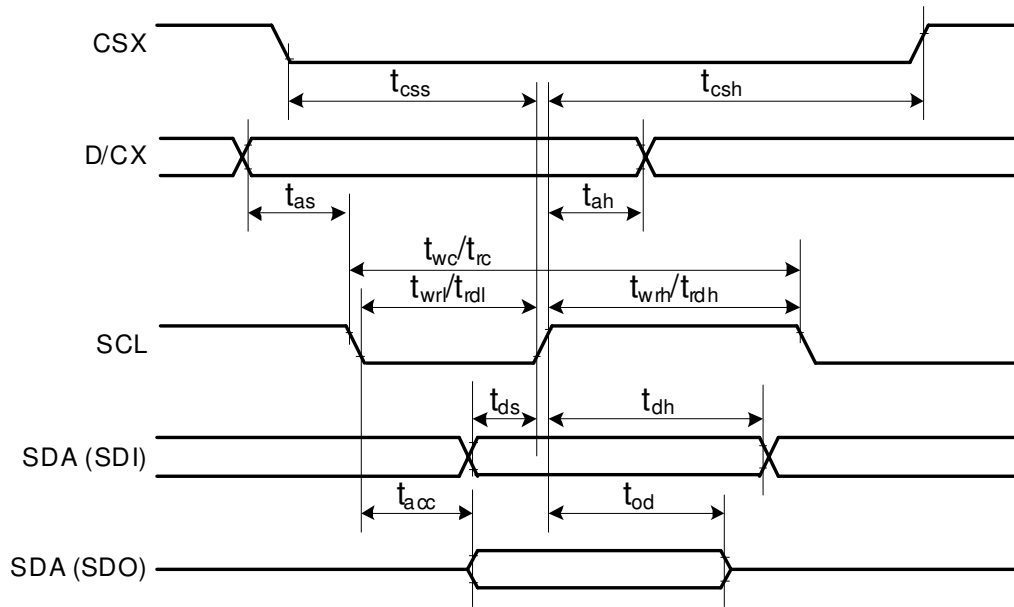


Signal	Symbol	Parameter	min	max	Unit	Description
SCL	tscycw	Serial Clock Cycle (Write)	100	-	ns	
	tshw	SCL "H" Pulse Width (Write)	40	-	ns	
	tslw	SCL "L" Pulse Width (Write)	40	-	ns	
	tscycr	Serial Clock Cycle (Read)	150	-	ns	
	tshr	SCL "H" Pulse Width (Read)	60	-	ns	
	tslr	SCL "L" Pulse Width (Read)	60	-	ns	
SDA / SDI (Input)	tsds	Data setup time (Write)	30	-	ns	
	tsdh	Data hold time (Write)	30	-	ns	
SDA / SDO (Output)	tacc	Access time (Read)	10	-	ns	
	toh	Output disable time (Read)	10	50	ns	
CSX	tsc	SCL-CSX	20	-	ns	
	tchw	CSX "H" Pulse Width	40	-	ns	
	tcss	CSX-SCL Time	60	-	ns	
	tch		65	-	ns	

Note: $T_a = 25\text{ }^{\circ}\text{C}$, $V_{DDI}=1.65\text{V to }3.3\text{V}$, $V_{CI}=2.5\text{V to }3.3\text{V}$, $AGND=VSS=0\text{V}$

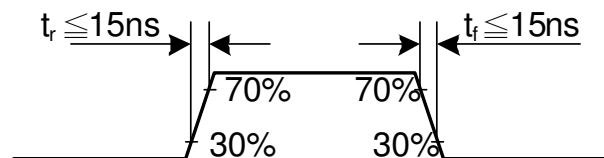


1.4 Display Serial Interface Timing Characteristics (4-line SPI system)

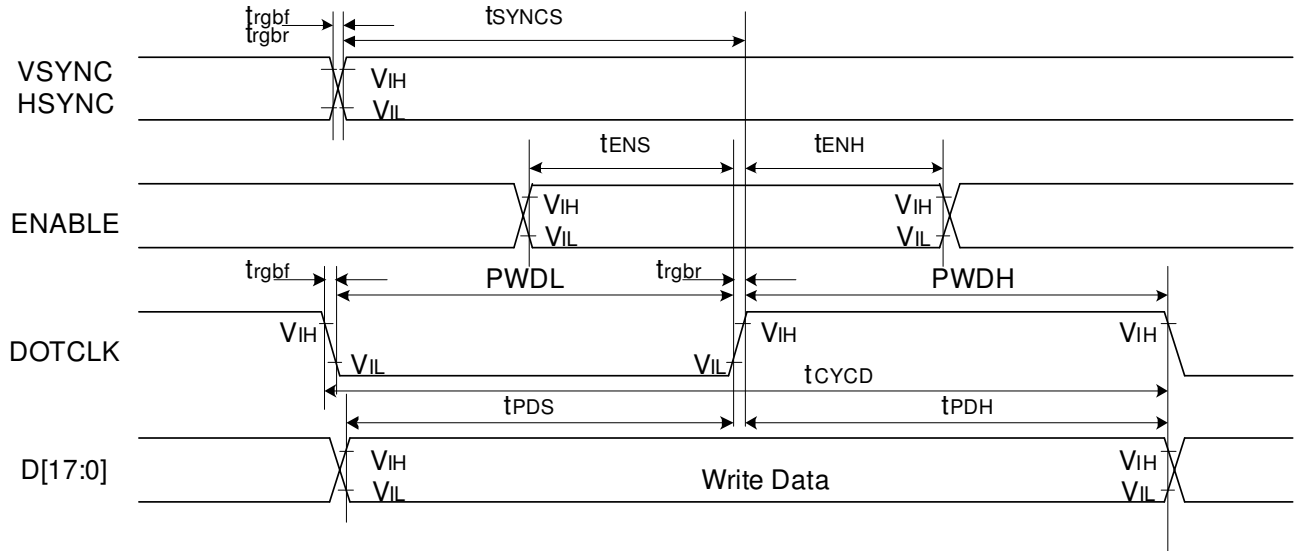


Signal	Symbol	Parameter	min	max	Unit	Description
CSX	tcss	Chip select time (Write)	40	-	ns	
	tcsh	Chip select hold time (Read)	40	-	ns	
SCL	twc	Serial clock cycle (Write)	100	-	ns	
	twrh	SCL "H" pulse width (Write)	40	-	ns	
	twrl	SCL "L" pulse width (Write)	40	-	ns	
	trc	Serial clock cycle (Read)	150	-	ns	
	trdh	SCL "H" pulse width (Read)	60	-	ns	
	trdl	SCL "L" pulse width (Read)	60	-	ns	
D/CX	tas	D/CX setup time	10	-		
	tah	D/CX hold time (Write / Read)	10	-		
SDA / SDI (Input)	tds	Data setup time (Write)	30	-	ns	
	tdh	Data hold time (Write)	30	-	ns	
SDA / SDO (Output)	tacc	Access time (Read)	10	-	ns	For maximum CL=30pF
	tod	Output disable time (Read)	10	50	ns	For minimum CL=8pF

Note: $T_a = 25\text{ }^{\circ}\text{C}$, $V_{DDI}=1.65\text{V to }3.3\text{V}$, $V_{CI}=2.5\text{V to }3.3\text{V}$, $AGND=VSS=0\text{V}$

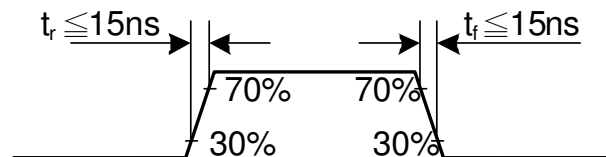


1.5 Parallel 18/16/6-bit RGB Interface Timing Characteristics



Signal	Symbol	Parameter	min	max	Unit	Description
VSYNC / HSYNC	tSYNCS	VSYNC/HSYNC setup time	15	-	ns	18/16-bit bus RGB interface mode
	tSYNCH	VSYNC/HSYNC hold time	15	-	ns	
DE	tENS	DE setup time	15	-	ns	
	tENH	DE hold time	15	-	ns	
D[17:0]	tPOS	Data setup time	15	-	ns	
	tPDH	Data hold time	15	-	ns	
DOTCLK	PWDH	DOTCLK high-level period	15	-	ns	
	PWDL	DOTCLK low-level period	15	-	ns	
	tCYCD	DOTCLK cycle time	100	-	ns	
	trgbr, trgbf	DOTCLK,HSYNC,VSYNC rise/fall time	-	15	ns	
VSYNC / HSYNC	tSYNCS	VSYNC/HSYNC setup time	15	-	ns	6-bit bus RGB interface mode
	tSYNCH	VSYNC/HSYNC hold time	15	-	ns	
DE	tENS	DE setup time	15	-	ns	
	tENH	DE hold time	15	-	ns	
D[17:0]	tPOS	Data setup time	15	-	ns	
	tPDH	Data hold time	15	-	ns	
DOTCLK	PWDH	DOTCLK high-level pulse period	15	-	ns	
	PWDL	DOTCLK low-level pulse period	15	-	ns	
	tCYCD	DOTCLK cycle time	100	-	ns	
	trgbr, trgbf	DOTCLK,HSYNC,VSYNC rise/fall time	-	15	ns	

Note: Ta = -30 to 70 °C, VDDI=1.65V to 3.3V, VCI=2.5V to 3.3V, AGND=VSS=0V





INSTRUCTION DESCRIPTION(ILITEK's ILI9341V

Regulative Command Set													
Command Function	D/CX	RDX	WRX	D17-8	D7	D6	D5	D4	D3	D2	D1	D0	Hex
No Operation	0	1	↑	XX	0	0	0	0	0	0	0	0	00h
Software Reset	0	1	↑	XX	0	0	0	0	0	0	0	1	01h
Read Display Identification Information	0	1	↑	XX	0	0	0	0	0	1	0	0	04h
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	ID1 [7:0]								XX
	1	↑	1	XX	ID2 [7:0]								XX
	1	↑	1	XX	ID3 [7:0]								XX
Read Display Status	0	1	↑	XX	0	0	0	0	1	0	0	1	09h
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	D [31:25]							X	00
	1	↑	1	XX	X	D [22:20]			D [19:16]				61
	1	↑	1	XX	X	X	X	X	X	D [10:8]			00
	1	↑	1	XX	D [7:5]			X	X	X	X	X	00
Read Display Power Mode	0	1	↑	XX	0	0	0	0	1	0	1	0	0Ah
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	D [7:2]						0	0	08
Read Display MADCTL	0	1	↑	XX	0	0	0	0	1	0	1	1	0Bh
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	D [7:2]						0	0	00
Read Display Pixel Format	0	1	↑	XX	0	0	0	0	1	1	0	0	0Ch
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	RIM	DPI [2:0]			X	DBI [2:0]			06
Read Display Image Format	0	1	↑	XX	0	0	0	0	1	1	0	1	0Dh
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	X	X	X	X	X	D [2:0]			00
Read Display Signal Mode	0	1	↑	XX	0	0	0	0	1	1	1	0	0Eh
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	D [7:2]						0	0	00
Read Display Self-Diagnostic Result	0	1	↑	XX	0	0	0	0	1	1	1	1	0Fh
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	D [7:6]			X	X	X	X	X	00
Enter Sleep Mode	0	1	↑	XX	0	0	0	1	0	0	0	0	10h
Sleep OUT	0	1	↑	XX	0	0	0	1	0	0	0	1	11h
Partial Mode ON	0	1	↑	XX	0	0	0	1	0	0	1	0	12h
Normal Display Mode ON	0	1	↑	XX	0	0	0	1	0	0	1	1	13h
Display Inversion OFF	0	1	↑	XX	0	0	1	0	0	0	0	0	20h
Display Inversion ON	0	1	↑	XX	0	0	1	0	0	0	0	1	21h
Gamma Set	0	1	↑	XX	0	0	1	0	0	1	1	0	26h
	1	1	↑	XX	GC [7:0]							01	
Display OFF	0	1	↑	XX	0	0	1	0	1	0	0	0	28h
Display ON	0	1	↑	XX	0	0	1	0	1	0	0	1	29h
Column Address Set	0	1	↑	XX	0	0	1	0	1	0	1	0	2Ah
	1	1	↑	XX	SC [15:8]							XX	
	1	1	↑	XX	SC [7:0]							XX	
	1	1	↑	XX	EC [15:8]							XX	
	1	1	↑	XX	EC [7:0]							XX	
Page Address Set	0	1	↑	XX	0	0	1	0	1	0	1	1	2Bh
	1	1	↑	XX	SP [15:8]							XX	
	1	1	↑	XX	SP [7:0]							XX	
	1	1	↑	XX	EP [15:8]							XX	
	1	1	↑	XX	EP [7:0]							XX	



Memory Write	0	1	↑	XX	0	0	1	0	1	1	0	0	2Ch
	1	1	↑	D [17:0]									XX
Color SET	0	1	↑	XX	0	0	1	0	1	1	0	1	2Dh
	1	↑	1	XX			R00 [5:0]						XX
	1	↑	1	XX			Rnn [5:0]						XX
	1	↑	1	XX			R31 [5:0]						XX
	1	↑	1	XX			G00 [5:0]						XX
	1	↑	1	XX			Gnn [5:0]						XX
	1	↑	1	XX			G64 [5:0]						XX
	1	↑	1	XX			B00 [5:0]						XX
	1	↑	1	XX			Bnn [5:0]						XX
	1	↑	1	XX			B31 [5:0]						XX
Memory Read	0	1	↑	XX	0	0	1	0	1	1	1	0	2Eh
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	D [17:0]									XX
Partial Area	0	1	↑	XX	0	0	1	1	0	0	0	0	30h
	1	1	↑	XX	SR [15:8]								00
	1	1	↑	XX	SR [7:0]								00
	1	1	↑	XX	ER [15:8]								01
	1	1	↑	XX	ER [7:0]								3F
Vertical Scrolling Definition	0	1	↑	XX	0	0	1	1	0	0	1	1	33h
	1	1	↑	XX	TFA [15:8]								00
	1	1	↑	XX	TFA [7:0]								00
	1	1	↑	XX	VSA [15:8]								01
	1	1	↑	XX	VSA [7:0]								40
	1	1	↑	XX	BFA [15:8]								00
	1	1	↑	XX	BFA [7:0]								00
Tearing Effect Line OFF	0	1	↑	XX	0	0	1	1	0	1	0	0	34h
Tearing Effect Line ON	0	1	↑	XX	0	0	1	1	0	1	0	1	35h
	1	1	↑	XX	X	X	X	X	X	X	X	M	00
Memory Access Control	0	1	↑	XX	0	0	1	1	0	1	1	0	36h
	1	1	↑	XX	MY	MX	MV	ML	BGR	MH	X	X	00
Vertical Scrolling Start Address	0	1	↑	XX	0	0	1	1	0	1	1	1	37h
	1	1	↑	XX	VSP [15:8]								00
	1	1	↑	XX	VSP [7:0]								00
Idle Mode OFF	0	1	↑	XX	0	0	1	1	1	0	0	0	38h
Idle Mode ON	0	1	↑	XX	0	0	1	1	1	0	0	1	39h
Pixel Format Set	0	1	↑	XX	0	0	1	1	1	0	1	0	3Ah
	1	1	↑	XX	X	DPI [2:0]			X	DBI [2:0]			66
Write Memory Continue	0	1	↑	XX	0	0	1	1	1	1	0	0	3Ch
	1	1	↑	D [17:0]									XX
Read Memory Continue	0	1	↑	XX	0	0	1	1	1	1	1	0	3Eh
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	D [17:0]									XX
Set Tear Scanline	0	1	↑	XX	0	1	0	0	0	1	0	0	44h
	1	1	↑	XX	X	X	X	X	X	X	X	STS [8]	00
	1	1	↑	XX	STS [7:0]								00
Get Scanline	0	1	↑	XX	0	1	0	0	0	1	0	1	45h
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	X	X	X	X	X	X	GTS [9:8]		00
	1	↑	1	XX	GTS [7:0]								00
Write Display Brightness	0	1	↑	XX	0	1	0	1	0	0	0	1	51h
	1	1	↑	XX	DBV [7:0]								00



Read Display Brightness	0	1	↑	XX	0	1	0	1	0	0	1	0	52h
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	DBV [7:0]								00
Write CTRL Display	0	1	↑	XX	0	1	0	1	0	0	1	1	53h
	1	1	↑	XX	X	X	BCTRL	X	DD	BL	X	X	00
Read CTRL Display	0	1	↑	XX	0	1	0	1	0	1	0	0	54h
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	X	X	BCTRL	X	DD	BL	X	X	00
Write Content Adaptive Brightness Control	0	1	↑	XX	0	1	0	1	0	1	0	1	55h
	1	1	↑	XX	X	X	X	X	X	X	C [1:0]		00
Read Content Adaptive Brightness Control	0	1	↑	XX	0	1	0	1	0	1	1	0	56h
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	X	X	X	X	X	X	C [1:0]		00
Write CABC Minimum Brightness	0	1	↑	XX	0	1	0	1	1	1	1	0	5Eh
	1	1	↑	XX	CMB [7:0]								00
Read CABC Minimum Brightness	0	1	↑	XX	0	1	0	1	0	1	1	1	5Fh
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	CMB [7:0]								00
Read ID1	0	1	↑	XX	1	1	0	1	1	0	1	0	DAh
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	Module's Manufacture [7:0]								XX
Read ID2	0	1	↑	XX	1	1	0	1	1	0	1	1	DBh
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	LCD Module / Driver Version [7:0]								XX
Read ID3	0	1	↑	XX	1	1	0	1	1	1	0	0	DCh
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	LCD Module / Driver ID [7:0]								XX

Extended Command Set													
Command Function	D/CX	RDX	WRX	D17-8	D7	D6	D5	D4	D3	D2	D1	D0	Hex
RGB Interface Signal Control	0	1	↑	XX	1	0	1	1	0	0	0	0	B0h
	1	1	↑	XX	ByPass MODE	RCM [1:0]		X	VSPL	HSPL	DPL	EPL	40
Frame Control (In Normal Mode)	0	1	↑	XX	1	0	1	1	0	0	0	1	B1h
	1	1	↑	XX	X	X	X	X	X	X	DIVA [1:0]		00
	1	1	↑	XX	X	X	X	RTNA [4:0]					1B
Frame Control (In Idle Mode)	0	1	↑	XX	1	0	1	1	0	0	1	0	B2h
	1	1	↑	XX	X	X	X	X	X	X	DIVB [1:0]		00
	1	1	↑	XX	X	X	X	RTNB [4:0]					1B
Frame Control (In Partial Mode)	0	1	↑	XX	1	0	1	1	0	0	1	1	B3h
	1	1	↑	XX	X	X	X	X	X	X	DIVC [1:0]		00
	1	1	↑	XX	X	X	X	RTNC [4:0]					1B
Display Inversion Control	0	1	↑	XX	1	0	1	1	0	1	0	0	B4h
	1	1	↑	XX	X	X	X	X	X	NLA	NLB	NLC	02
Blanking Porch Control	0	1	↑	XX	1	0	1	1	0	1	0	1	B5h
	1	1	↑	XX	0	VFP [6:0]							02
	1	1	↑	XX	0	VBP [6:0]							02
	1	1	↑	XX	0	0	0	HFP [4:0]					0A
	1	1	↑	XX	0	0	0	HBP [4:0]					14



Display Function Control	0	1	↑	XX	1	0	1	1	0	1	1	0	B6h	
	1	1	↑	XX	X	X	X	X	PTG [1:0]		PT [1:0]		0A	
	1	1	↑	XX	REV	GS	SS	SM	ISC [3:0]					82
	1	1	↑	XX	X	X	NL [5:0]						27	
	1	1	↑	XX	X	X	PCDIV [5:0]						XX	
Entry Mode Set	0	1	↑	XX	1	0	1	1	0	1	1	1	B7h	
	1	1	↑	XX	X	X	X	X	DSTB	GON	DTE	GAS	07	
Backlight Control 1	0	1	↑	XX	1	0	1	1	1	0	0	0	B8h	
	1	1	↑	XX	X	X	X	X	X	X	X	X	XX	
	1	1	↑	XX	X	X	X	X	TH_UI [3:0]					04
Backlight Control 2	0	1	↑	XX	1	0	1	1	1	0	0	1	B9h	
	1	1	↑	XX	X	X	X	X	X	X	X	X	XX	
	1	1	↑	XX	TH_MV [3:0]					TH_ST [3:0]				
Backlight Control 3	0	1	↑	XX	1	0	1	1	1	0	1	0	BAh	
	1	1	↑	XX	X	X	X	X	X	X	X	X	XX	
	1	1	↑	XX	X	X	X	X	DTH_UI [3:0]					04
Backlight Control 4	0	1	↑	XX	1	0	1	1	1	0	1	1	BBh	
	1	1	↑	XX	X	X	X	X	X	X	X	X	XX	
	1	1	↑	XX	DTH_MV [3:0]					DTH_ST [3:0]				
Backlight Control 5	0	1	↑	XX	1	0	1	1	1	1	0	0	BCh	
	1	1	↑	XX	X	X	X	X	X	X	X	X	XX	
	1	1	↑	XX	DIM2 [3:0]					X	DIM1 [2:0]			44
Backlight Control 7	0	1	↑	XX	1	0	1	1	1	1	1	0	BEh	
	1	1	↑	XX	PWM_DIV [7:0]								0F	
Backlight Control 8	0	1	↑	XX	1	0	1	1	1	1	1	1	BFh	
	1	1	↑	XX	X	X	X	X	X	LEDONR	LEDONPOL	LEDPWMOPL	00	
Power Control 1	0	1	↑	XX	1	1	0	0	0	0	0	0	C0h	
	1	1	↑	XX	X	X	VRH [5:0]						26	
Power Control 2	0	1	↑	XX	1	1	0	0	0	0	0	1	C1h	
	1	1	↑	XX	X	X	X	X	X	BT [2:0]			00	
VCOM Control 1	0	1	↑	XX	1	1	0	0	0	1	0	1	C5h	
	1	1	↑	XX	X	VMH [6:0]							31	
	1	1	↑	XX	X	VML [6:0]							3C	
VCOM Control 2	0	1	↑	XX	1	1	0	0	0	1	1	1	C7h	
	1	1	↑	XX	nVM	VMF [6:0]							C0	
NV Memory Write	0	1	↑	XX	1	1	0	1	0	0	0	0	D0h	
	1	1	↑	XX	X	X	X	X	X	PGM_ADR [2:0]				00
	1	1	↑	XX	PGM_DATA [7:0]									XX
NV Memory Protection Key	0	1	↑	XX	1	1	0	1	0	0	0	1	D1h	
	1	1	↑	XX	KEY [23:16]									55
	1	1	↑	XX	KEY [15:8]									AA
	1	1	↑	XX	KEY [7:0]									66
NV Memory Status Read	0	1	↑	XX	1	1	0	1	0	0	1	0	D2h	
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX	
	1	↑	1	XX	X	ID2_CNT [2:0]			X	ID1_CNT [2:0]			XX	
	1	↑	1	XX	BUSY	VMF_CNT [2:0]			X	ID3_CNT [2:0]			XX	



Read ID4	0	↑	1	XX	1	1	0	1	0	0	1	1	D3h
	1	↑	1	XX	X	X	X	X	X	X	X	X	XX
	1	↑	1	XX	0	0	0	0	0	0	0	0	00
	1	↑	1	XX	1	0	0	1	0	0	1	1	93
	1	↑	1	XX	0	1	0	0	0	0	0	1	41
Positive Gamma Correction	0	1	↑	XX	1	1	1	0	0	0	0	0	E0h
	1	1	↑	XX	X	X	X	X	VP0 [3:0]				08
	1	1	↑	XX	X	X	VP1 [5:0]				0E		
	1	1	↑	XX	X	X	VP2 [5:0]				12		
	1	1	↑	XX	X	X	X	X	VP4 [3:0]				05
	1	1	↑	XX	X	X	X	VP6 [4:0]				03	
	1	1	↑	XX	X	X	X	X	VP13 [3:0]				09
	1	1	↑	XX	X	VP20 [6:0]				47			
	1	1	↑	XX	VP36 [3:0]				VP27 [3:0]				86
	1	1	↑	XX	X	VP43 [6:0]				2B			
	1	1	↑	XX	X	X	X	X	VP50 [3:0]				0B
	1	1	↑	XX	X	X	X	VP57 [4:0]				04	
	1	1	↑	XX	X	X	X	X	VP59 [3:0]				00
	1	1	↑	XX	X	X	VP61 [5:0]				00		
	1	1	↑	XX	X	X	VP62 [5:0]				00		
	1	1	↑	XX	X	X	X	X	VP63 [3:0]				00
Negative Gamma Correction	0	1	↑	XX	1	1	1	0	0	0	0	1	E1h
	1	1	↑	XX	X	X	X	X	VN0 [3:0]				08
	1	1	↑	XX	X	X	VN1 [5:0]				1A		
	1	1	↑	XX	X	X	VN2 [5:0]				20		
	1	1	↑	XX	X	X	X	X	VN4 [3:0]				07
	1	1	↑	XX	X	X	X	VN6 [4:0]				0E	
	1	1	↑	XX	X	X	X	X	VN13 [3:0]				05
	1	1	↑	XX	X	VN20 [6:0]				3A			
	1	1	↑	XX	VN36 [3:0]				VN27 [3:0]				8A
	1	1	↑	XX	X	VN43 [6:0]				40			
	1	1	↑	XX	X	X	X	X	VN50 [3:0]				04
	1	1	↑	XX	X	X	X	VN57 [4:0]				18	
	1	1	↑	XX	X	X	X	X	VN59 [3:0]				0F
	1	1	↑	XX	X	X	VN61 [5:0]				3F		
	1	1	↑	XX	X	X	VN62 [5:0]				3F		
	1	1	↑	XX	X	X	X	X	VN63 [3:0]				0F
Digital Gamma Control 1	0	1	↑	XX	1	1	1	0	0	0	1	0	E2h
1 st Parameter	1	1	↑	XX	RCA0 [3:0]				BCA0 [3:0]				XX
:	1	1	↑	XX	RCAx [3:0]				BCAx [3:0]				XX
16 th Parameter	1	1	↑	XX	RCA15 [3:0]				BCA15 [3:0]				XX
Digital Gamma Control 2	0	1	↑	XX	1	1	1	0	0	0	1	1	E3h
1 st Parameter	1	1	↑	XX	RFA0 [3:0]				BFA0 [3:0]				XX
:	1	1	↑	XX	RFAx [3:0]				BFAx [3:0]				XX
64 th Parameter	1	1	↑	XX	RFA63 [3:0]				BFA63 [3:0]				XX
Interface Control	0	1	↑	XX	1	1	1	1	0	1	1	0	F6h
	1	1	↑	XX	MY_EOR	MX_EOR	MV_EOR	X	BGR_EOR	X	X	WEMODE	01
	1	1	↑	XX	X	X	EPF [1:0]		X	X	MDT [1:0]		00
	1	1	↑	XX	X	X	ENDIAN	X	DM [1:0]		RM	RIM	00

Note 1: Undefined commands are treated as NOP (00h) command.

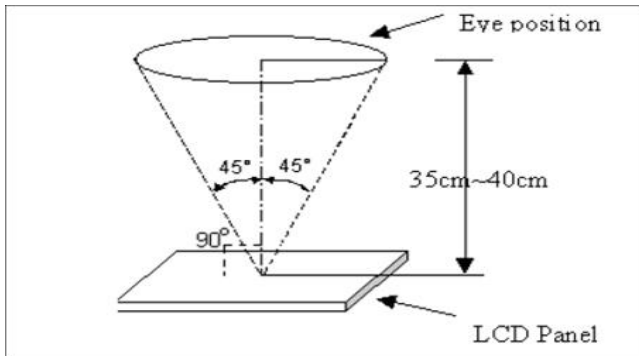
Note 2: B0 to D9 and DE to FF are for factory use of display supplier. USER can decide if these commands are available or they are treated as NOP (00h) commands before shipping to USER. Default value is NOP (00h).

Note 3: Commands 10h, 12h, 13h, 26h, 28h, 29h, 30h, 36h (Bit B4 only), 38h and 39h are updated during V-SYNC when ILI9341V is in Sleep OUT mode to avoid abnormal visual effects. During Sleep IN mode, these commands are updated immediately. Read status (09h), Read display power mode (0Ah), Read display MADCTL (0Bh), Read display pixel format (0Ch), Read display image mode (0Dh), Read display signal mode (0Eh) and Read display self diagnostic result (0Fh) of these commands are updated immediately both in Sleep IN mode and Sleep OUT mode.

**■ RELIABILITY TEST**

No.	Test Item	Test Condition	Remark
1	High Temperature Storage	$80 \pm 2^{\circ}\text{C}/96 \text{ hours}$	The test result shall be evaluated after the sample has been left at room temperature and humidity for 2 hours without load. No condensation shall be accepted. The sample shall be free from defects: 1.Air bubble in the LCD; 2.Sealleak; 3.Non-display; 4.Missing segments; 5.Glass crack;
2	Low Temperature Storage	$-30 \pm 2^{\circ}\text{C}/96 \text{ hours}$	
3	High Temperature Operating	$70 \pm 2^{\circ}\text{C}/96 \text{ hours}$	
4	Low Temperature Operating	$-20 \pm 2^{\circ}\text{C}/96 \text{ hours}$	
5	Temperature Cycle storage	$-30 \pm 2^{\circ}\text{C} \sim 25 \sim 80 \pm 2^{\circ}\text{C} \times 10 \text{cycles}$ (30min.) (5min.) (30min.)	
6	Damp proof Test operating	$60^{\circ}\text{C} \pm 5^{\circ}\text{C} \times 90\% \text{RH}/96 \text{hours}$	
7	Vibration Test	10Hz~150Hz, 100m/s^2 , 120min	
8	Drop test(package state)	800mm, concrete floor, 1corner,	
9	ESD test	C=150pF, R=330 Ω Air: $\pm 8 \text{KV}$, 30times Contact: $\pm 4 \text{KV}$, 20times	
10	Shock test	Half-sine, wave, 300m/s	

■ INSPECTION CRITERION

 OUTGOING QUALITY STANDARD	PAGE 1 OF 5
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA	
This specification is made to be used as the standard acceptance/rejection criteria for TFT module. 1 Sample plan 1.1 Lot size: Quantity per shipment lot per model 1.2 Sampling type: Normal inspection,Single sampling 1.3 Inspection level: II 1.4 Sampling table: MIL-STD-105D 1.5 Acceptable quality level (AQL) Major defect: AQL=0.65 Minor defect: AQL=1.50 2. Inspection condition 2.1 Ambient conditions: a. Temperature: Room temperature $25 \pm 5^{\circ}\text{C}$ b. Humidity: $(60 \pm 10)\% \text{RH}$ c. Illumination: Single fluorescent lamp non-directive (300 to 700 Lux) 2.2 Viewing distance: The distance between the LCD and the inspector' s eyes shall be at least $35 \pm 5\text{cm}$. 2.3 Viewing Angle U/D: $45^{\circ} / 45^{\circ}$, L/R: $45^{\circ} / 45^{\circ}$ 	



OUTGOING QUALITY STANDARD

PAGE 2 OF 5

TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

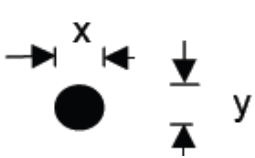
3. Inspection standards

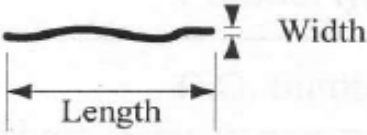
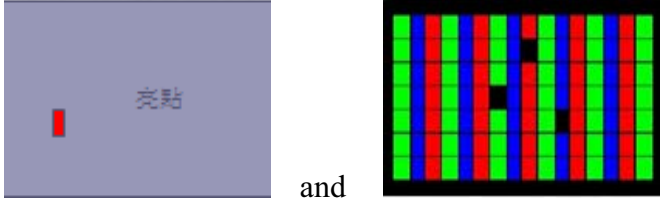
Defects are classified as major defects and minor defects according to the degree of defectiveness defined herein.

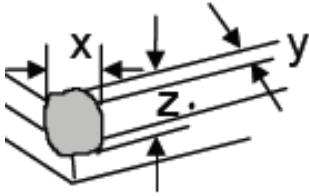
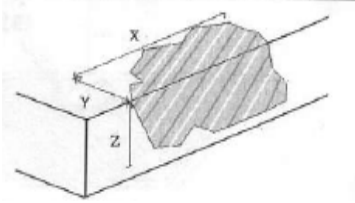
3.1 Major defect

Item No	Items to be inspected	Inspection Standard
3.1.1	All functional defects	1) No display 2) Display abnormally 3) Short circuit 4) line defect
3.1.2	Missing	Missing function component
3.1.3	Crack	Glasscrack

3.2 Minor defect

Item No	Items to be inspected	Inspection standard	
3.2.1	Spot Defect Including Black spot White spot Pinhole Foreign particle Polarizer dirt	For dark/white spot is defined $\varphi = (x + y) / 2$ 	
		Size $\varphi(\text{mm})$	Acceptable Quantity
		$\varphi \leq 0.10$	Ignore
		$0.10 < \varphi \leq 0.20$	3
		$0.20 < \varphi$	Not allowed

 OUTGOING QUALITY STANDARD		PAGE 3 OF 5	
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA			
3.2.2	Line Defect Including Black line White line Scratch	Define: 	
		Width(mm) Length(mm)	Acceptable Quantity
		$W \leq 0.03$	Ignore
		$0.03 < W \leq 0.05$ $L \leq 5.0$	2
		$0.05 < W$	Not allowed
3.2.3	Polarizer Dent/Bubble	Size φ (mm)	Acceptable Quantity
		$\varphi \leq 0.2$	Ignore
		$0.2 < \varphi \leq 0.4$	3
		$0.4 < \varphi$	Not allowed
3.2.4	Electrical Dot Defect	Bright and Black dot define: 	
		Inspection pattern: Full white, Full black, Red, green and blue screens	
		Item	Acceptable Quantity
		Dark dot defect	2
		Bright dot defect	0
		Total Dot	2

 OUTGOING QUALITY STANDARD		PAGE 4 OF 5	
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA			
3.2.5	Touch panel and glass defect	 1. Corner Fragment:	
		Size(mm)	Acceptable Quantity
		$X \leq 3\text{mm}$ $Y \leq 3\text{mm}$ $Z \leq T$	Ignore T: Glass thickness X: Length Y: Width Z: thickness
		 2. Side Fragment:	
		Size(mm)	Acceptable Quantity
		$X \leq 5.0\text{mm}$ $Y \leq 1\text{mm}$ $Z \leq T$	Ignore T: Glass thickness X: Length Y: Width Z: thickness
3.2.6	Touch panel spot	Size φ (mm)	Acceptable Quantity
		$\varphi \leq 0.15$	Ignore
		$0.15 < \varphi \leq 0.25$	3
		$0.25 < \varphi$	0



 OUTGOING QUALITY STANDARD		PAGE 5 OF 5	
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA			
3.2.7	Touch panel White line Scratch	Width(mm) Length(mm)	Acceptable Quantity
		$W \leq 0.03$	Ignore
		$0.03 < W \leq 0.05$ $L \leq 5.0$	3
		$0.05 < W$ or $L > 5$	Not allowed
3.2.8	Touch panel Newton ring	Compare with limit sample	

Note:

1. Dot defect is defined as the defecti ve area of the dot area is larger than 50% of the dot area .
2. The distance between two bright dot defects (red, green, blue, and white) should be larger than 15mm;
3. The distance between black dot defects or black and bright dot defects should be more than 5mm apart.
4. Polarizer bubble is defined as the bubble appears on active display area. The defect of polarizer bubble shall be ignored if the polarizer bubble appears on the outside of active display area.

■ PRECAUTIONS FOR USING LCD MODULES

1 Handling Precautions

- 1.1 The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- 1.2 If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- 1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
- 1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on it. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming in to contact with room temperature air.
- 1.5 If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
 - Isopropyl alcohol
 - Ethyl alcoholDo not scrub hard to avoid damaging the display surface.
- 1.6 Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solventsWipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contact with oil and fats.
- 1.7 Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- 1.8 Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- 1.9 Do not attempt to disassemble or process the LCD module.
- 1.10 NC terminal should be open. Do not connect anything.
- 1.11 If the logic circuit power is off, do not apply the input signals.
- 1.12 Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - Before removing LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.
 - Tools required for assembling, such as soldering irons, must be properly grounded. Make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
 - To reduce the amount of static electricity generated, do not conduct assembling

and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dry. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.

- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

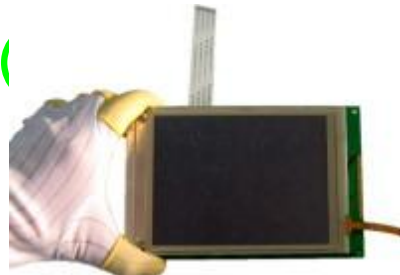
1.13 Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.

- Do not alter, modify or change the shape of the tab on the metal frame.
- Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
- Do not damage or modify the pattern writing on the printed circuit board.
- Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- Do not drop, bend or twist the LCM.

2 Handling precaution for LCM

2.1 LCM is easy to be damaged. Please note below and be careful for handling.

2.2 Correct handling:

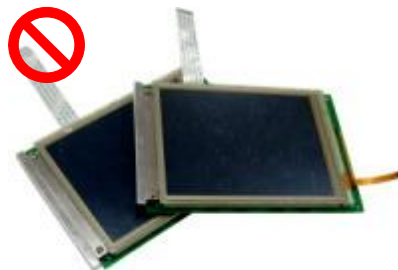


As above picture, please handle with anti-static gloves around LCM edges.

2.3 Incorrect handling:



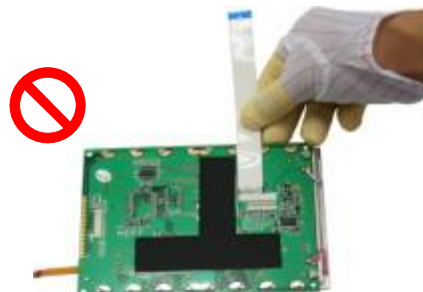
Please don't touch IC directly.



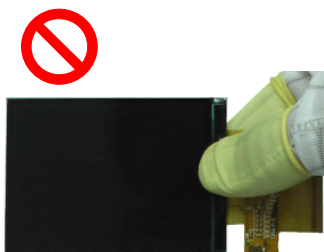
Please don't stack LCM.



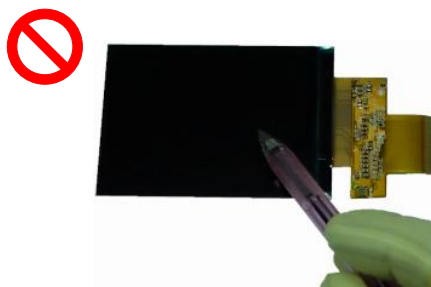
Please don't hold the surface of panel.



Please don't stretch interface of output, such as FPC cable.



Please don't hold the surface of IC.



Please don't operate with sharp stick such as pens.

3 Storage Precautions

3.1 When storing the LCD modules, the following precaution are necessary.

- 3.1.1 Store them in a sealed polyethylene bag. If properly sealed, there is no need for the desiccant.
- 3.1.2 Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C, and keep the relative humidity between 40%RH and 60%RH.
- 3.1.3 The polarizer surface should not come in contact with any other objects (We advise you to store them in the anti-static electricity container in which they were shipped).

3.2 Others

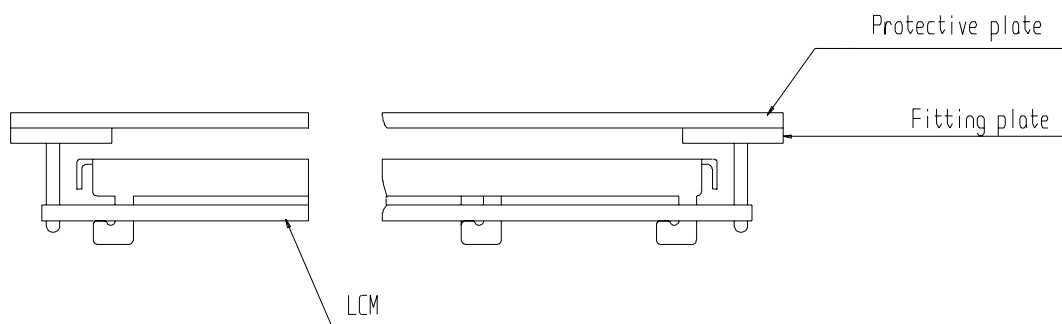
- 3.2.1 Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.
- 3.2.2 If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
- 3.2.3 To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.
 - 3.2.3.1 - Exposed area of the printed circuit board.
 - 3.2.3.2 - Terminal electrode sections.

4 USING LCD MODULES

4.1 Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

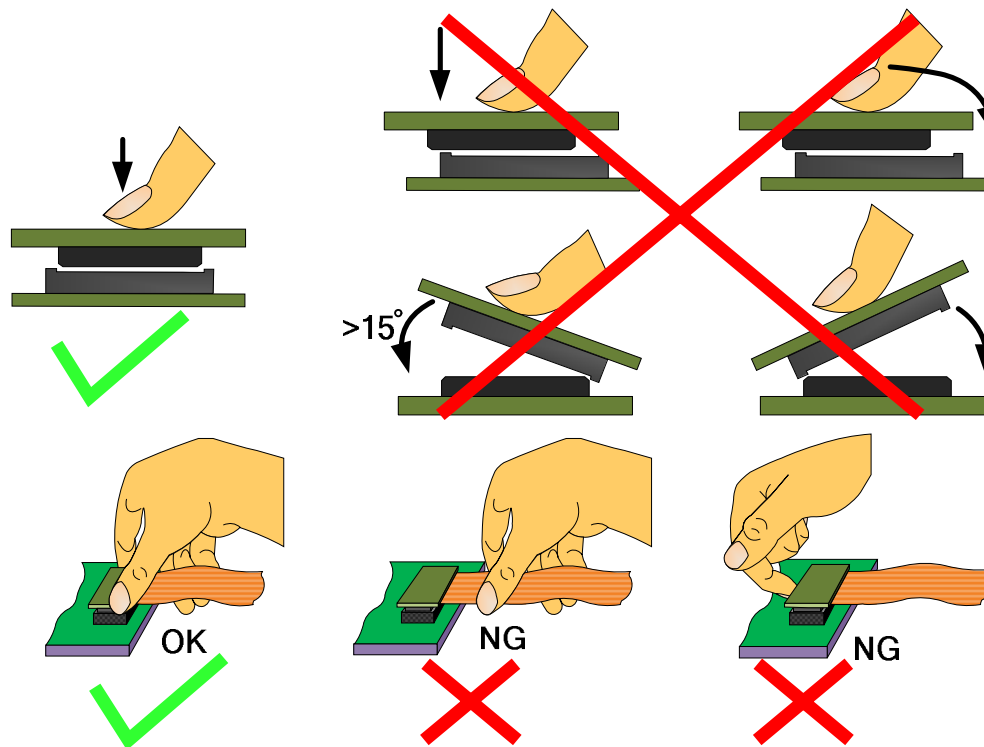
4.1.1 Cover the surface with a transparent protective plate to protect the polarizer and LC cell.



4.1.2 When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be ± 0.1 mm.

4.2 Precaution for assemble the module with BTB connector:

Please note the position of the male and female connector position, don't assemble or assemble like the method which the following picture shows



4.3 Precaution for soldering the LCM

	Manual soldering	Machine drag soldering	Machine press soldering
No RoHS Product	290°C ~350°C. Time : 3-5S.	330°C ~350°C. Speed : 15-17 mm/s.	300°C ~330°C. Time : 3-6S. Press: 0.8~1.2Mpa
RoHS Product	340°C ~370°C. Time : 3-5S.	350°C ~370°C. Speed : 15-17 mm/s.	330°C ~360°C. Time : 3-6S. Press: 0.8~1.2Mpa

- 4.3.1 If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation (This does not apply in the case of a non-halogen type of flux). It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.
- 4.3.2 When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- 4.3.3 When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

4.4 Precautions for Operation

- 4.4.1 Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.
- 4.4.2 It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- 4.4.3 Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operating temperature.
- 4.4.4 If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- 4.4.5 A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature, 50%RH or less is required.
- 4.4.6 Input logic voltage before apply analog high voltage such as LCD driving voltage when power on. Remove analog high voltage before logic voltage when power off the module. Input each signal after the positive/negative voltage becomes stable.
- 4.4.7 Please keep the temperature within the specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

4.5 Safety

- 4.5.1 It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- 4.5.2 If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

4.6 Limited Warranty

Unless agreed between Multi-Inno and the customer, Multi-Inno will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with Multi-Inno LCD acceptance standards (copies available upon request) for a period of one year from date of production. Cosmetic/visual defects must be returned to Multi-Inno within 90 days of shipment. Confirmation of such date shall be based on data code on product. The warranty liability of Multi-Inno limited to repair and/or replace on the terms set forth above. Multi-Inno will not be responsible for any subsequent or consequential events.

4.7 Return LCM under warranty

4.7.1 No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :

4.7.1.1 - Broken LCD glass.

4.7.1.2 - PCB eyelet is damaged or modified.

4.7.1.3 -PCB conductors damaged.

4.7.1.4 - Circuit modified in any way, including addition of components.

4.7.1.5 - PCB tampered with by grinding, engraving or painting varnish.

4.7.1.6 - Soldering to or modifying the bezel in any manner.

4.7.2 Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

■ PACKING SPECIFICATION

Please consult our technical department for detail information.

■ PRIOR CONSULT MATTER

- 1 For Multi-Inno standard products, we keep the right to change material, process ... for improving the product property without prior notice to our customer.
- 2 For OEM products, if any changes are needed which may affect the product property, we will consult with our customer in advance.
- 3 If you have special requirement about reliability condition, please let us know before you start the test on our samples.